

**DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

STETHOSCOPE

the specification of which is attached hereto unless the following box is checked:

☐

was filed on \_\_\_\_\_ as United States Application Number \_\_\_\_\_

or PCT International Application Number \_\_\_\_\_

and was amended on \_\_\_\_\_  
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56, including for continuation-in-part applications, material information which became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

I hereby claim foreign priority benefits under 35 U.S.C. § 119(a)-(d) or § 365(b), of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT international application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or any PCT international application, having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

NONE

(Number) (Country) (Day/Month/Year Filed)

☐ ☐

Yes No

(Number) (Country) (Day/Month/Year Filed)

☐ ☐

Yes No

(Number) (Country) (Day/Month/Year Filed)

☐ ☐

Yes No

I hereby claim the benefit under 35 U.S.C. § 119(e) of any United States provisional application(s) listed below.

(Application Number)

(Filing Date)

(Application Number)

(Filing Date)

(Application Number)

(Filing Date)

I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status - patented, pending, abandoned)

I (we) hereby appoint the following as our representative(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Please see attachment


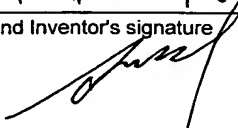
Send Correspondence to:

LINIAK, BERENATO & WHITE  
6550 Rock Spring Drive  
Suite 240  
Bethesda, Maryland 20817-1132  
U.S.A.

Direct Telephone Calls to:

(301)896-0600

I (we) hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor				
JACK LAM				
Inventor's signature				Date
				November 10, 2003
Residence:	City	State	Country	Citizenship
12F-A, No. 85, Sec. 4, Jen-Ai Rd., Taipei City, Taiwan			Hong Kong	
Mailing Address				
same as residence				
Full name of second joint inventor, if any				
YUNG HSIANG CHEN				
Second Inventor's signature				Date
				November 10, 2003
Residence:	City	State	Country	Citizenship
12F-A, No. 85, Sec. 4, Jen-Ai Rd., Taipei City, Taiwan			Taiwan	
Mailing Address				
same as residence				